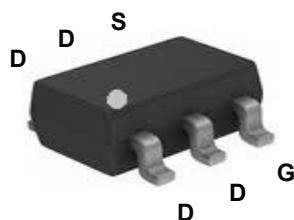
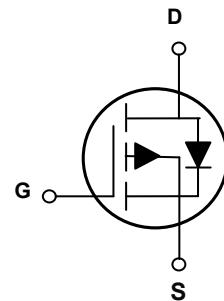


## Main Product Characteristics

BV <sub>DSS</sub>	-60V
R <sub>DS(ON)</sub>	96mΩ
I <sub>D</sub>	-3.3A



SOT-23-6L



Schematic Diagram



## Features and Benefits

- High efficiency and low on-resistance.
- Low gate-to-source voltage requirement.
- Small footprint and low profile package.
- RoHS compliant.

## 8 YgWjdjhcb

The GSFR0603 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## 5 Vgc`i hYAU ja ia 'FUhb[ gÁvõMG »ÔÅ} |^•• Áo@!, á^Á] ^&aaåD

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous (T <sub>A</sub> =25°C)	I <sub>D</sub>	-3.3	A
Drain Current-Continuous (T <sub>A</sub> =70°C)		-2.6	A
Drain Current-Pulsed <sup>1</sup>	I <sub>DM</sub>	-13.2	A
Single Pulse Avalanche Energy <sup>2</sup>	E <sub>AS</sub>	25	mJ
Single Pulse Avalanche Current <sup>2</sup>	I <sub>AS</sub>	-18	A
Power Dissipation (T <sub>A</sub> =25°C)	P <sub>D</sub>	2	W
Power Dissipation-Derate Above 25°C		0.016	W/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 To +150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 To +150	°C

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-60	-	-	V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=-60\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	-1	$\mu\text{A}$
		$V_{\text{DS}}=-48\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	-10	$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b>						
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-2\text{A}$	-	80	96	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-1\text{A}$	-	100	130	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1.0	-1.6	-2.5	V
Forward Transconductance	$g_{\text{fs}}$	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-1\text{A}$	-	3	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>2,3</sup>	$Q_g$	$V_{\text{DS}}=-30\text{V}, I_{\text{D}}=-1\text{A}, V_{\text{GS}}=-10\text{V}$	-	10	15	nC
Gate-Source Charge <sup>2,3</sup>	$Q_{\text{gs}}$		-	1.6	3.2	
Gate-Drain Charge <sup>2,3</sup>	$Q_{\text{gd}}$		-	3	6	
Turn-On Delay Time <sup>2,3</sup>	$t_{\text{d(on)}}$	$V_{\text{DD}}=-30\text{V}, R_{\text{G}}=6\Omega, V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-1\text{A}$	-	8	16	nS
Rise Time <sup>2,3</sup>	$t_r$		-	15.4	30	
Turn-Off Delay Time <sup>2,3</sup>	$t_{\text{d(off)}}$		-	42.8	80	
Fall Time <sup>2,3</sup>	$t_f$		-	8.4	16	
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	720	1080	pF
Output Capacitance	$C_{\text{oss}}$		-	42	63	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	32	48	
Gate Resistance	$R_g$	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1\text{MHz}$	-	22	-	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_s$	$V_G=V_D=0\text{V}, \text{Force Current}$	-	-	-3.3	A
Pulsed Source Current	$I_{\text{SM}}$		-	-	-6.6	A
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_s=-1\text{A}, T_J=25^\circ\text{C}$	-	-	-1	V
Reverse Recovery Time	$T_{\text{rr}}$	$V_R=-50\text{V}, I_s=-1\text{A}, di/dt=100\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$	-	30	-	nS
Reverse Recovery Charge	$Q_{\text{rr}}$		-	15	-	nC

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=-25\text{V}, V_{\text{GS}}=-10\text{V}, L=0.1\text{mH}, I_{\text{AS}}=-18\text{A}, R_{\text{G}}=25\Omega$ , starting  $T_J=25^\circ\text{C}$ .
3. Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operation temperature.

## Typical Electrical and Thermal Characteristic Curves

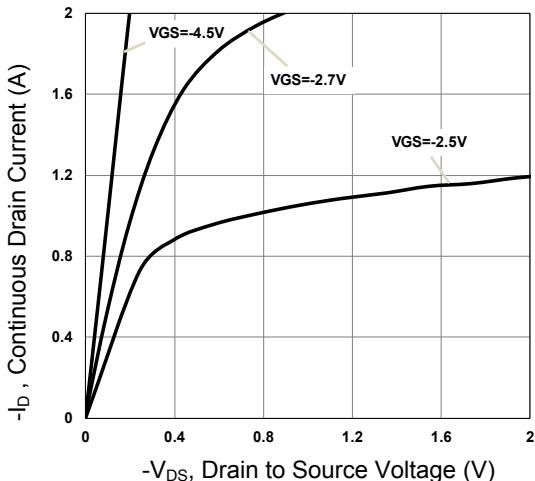


Fig.1 Typical Output Characteristics

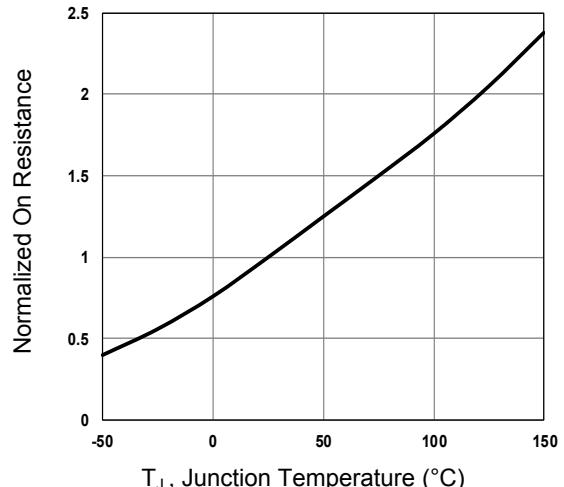


Fig.2 Normalized  $R_{DS(ON)}$  vs.  $T_J$

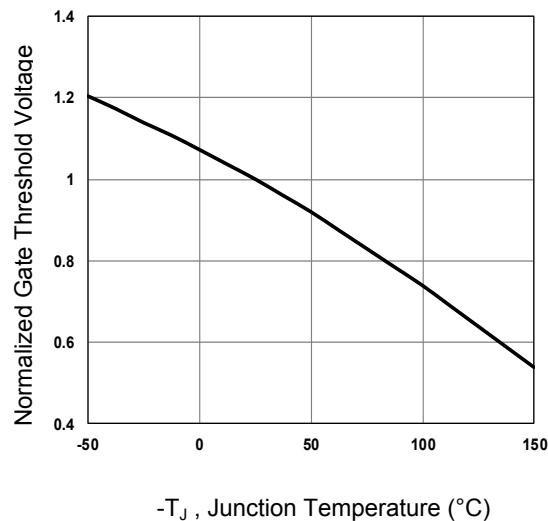


Fig.3 Normalized  $V_{th}$  vs.  $T_J$

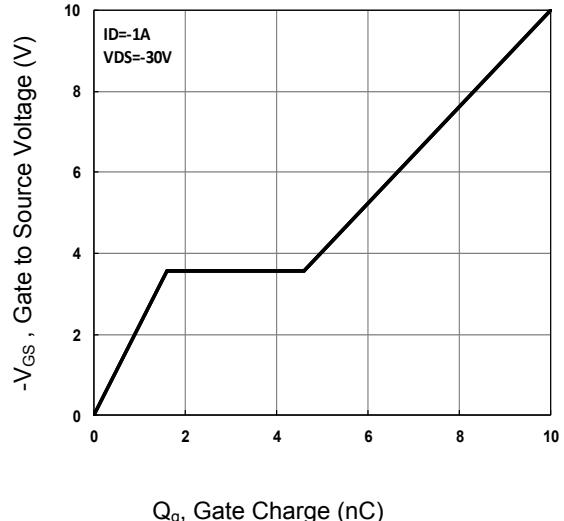


Fig.4 Gate Charge Waveform

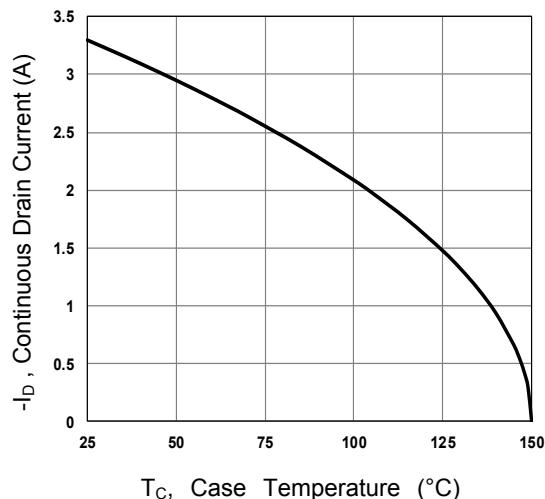


Fig.5 Continuous Drain Current vs.  $T_c$

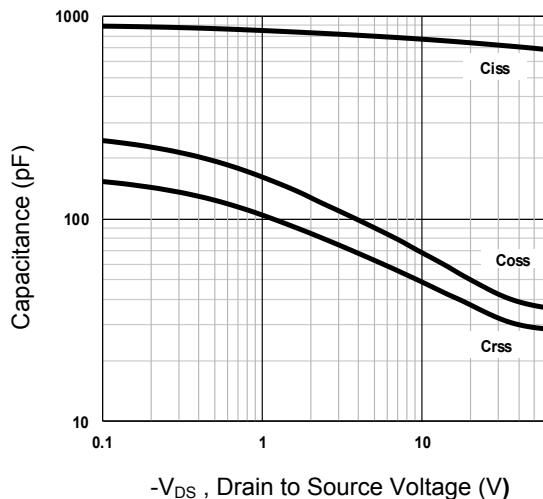
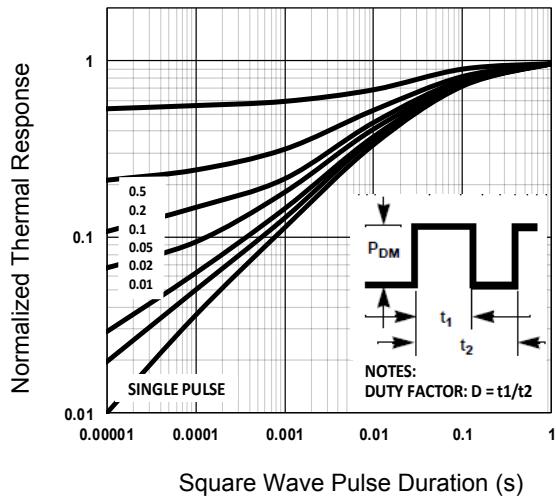
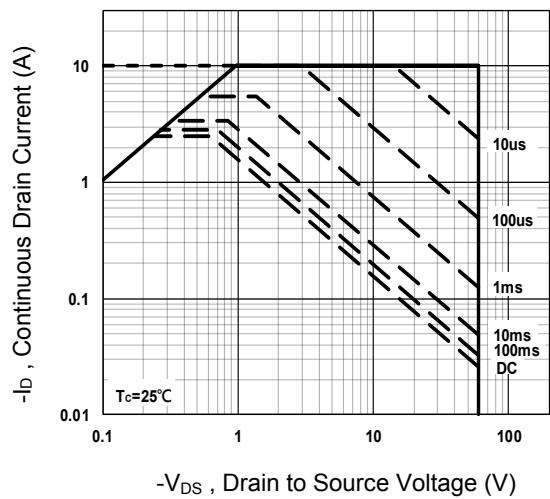


Fig.6 Capacitance Characteristics

## Typical Electrical and Thermal Characteristic Curves



**Fig.7 Normalized Transient Impedance**



**Fig.8 Maximum Safe Operation Area**

## Typical Electrical and Thermal Characteristic Curves

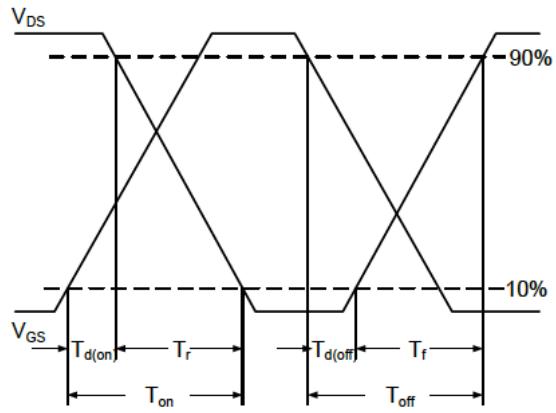


Fig.9 Switching Time Waveform

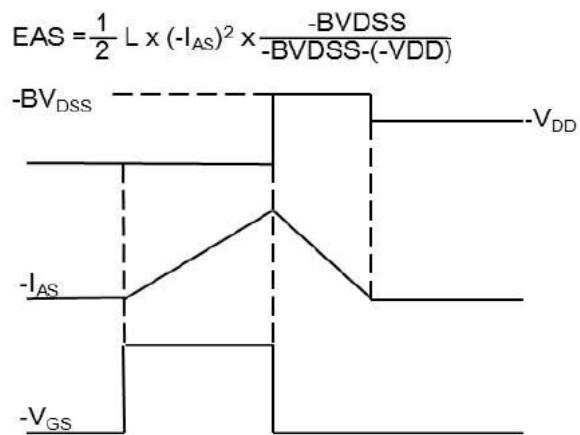
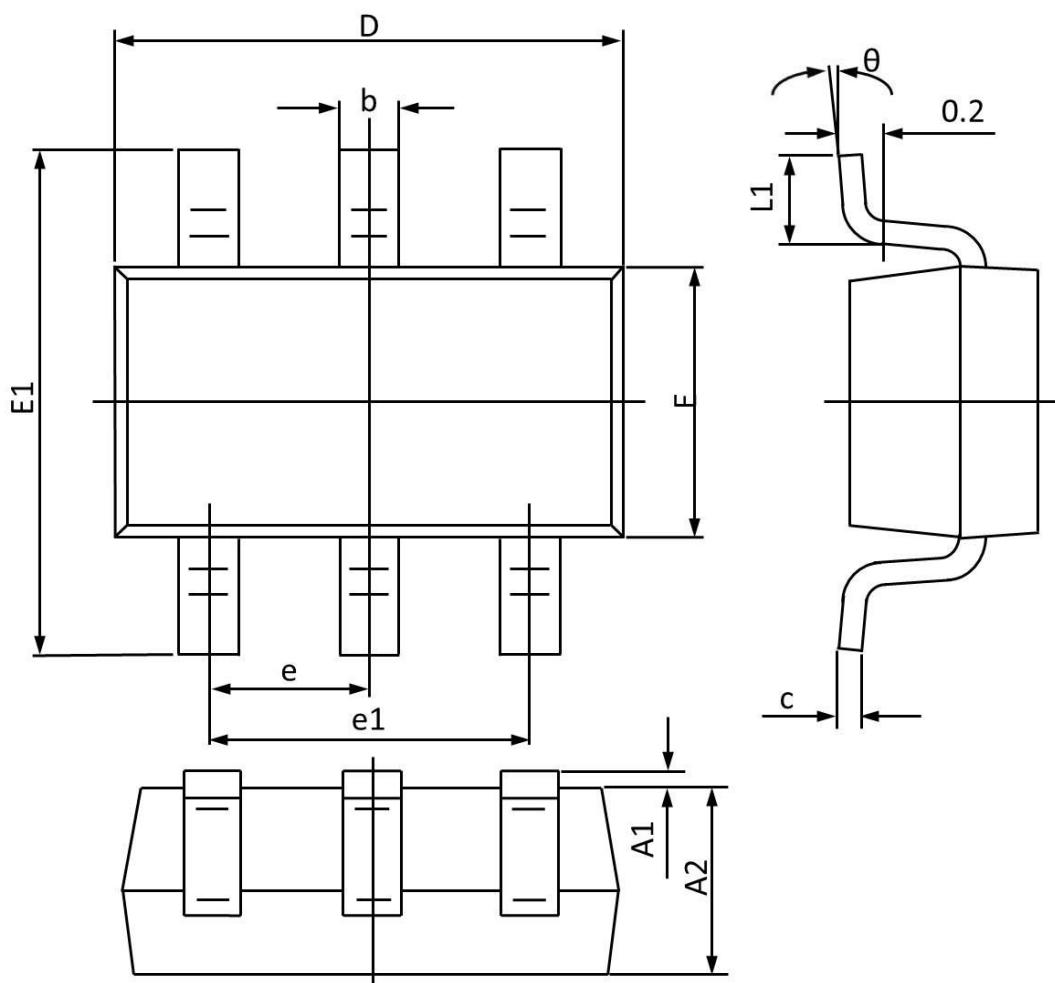


Fig.10 EAS Waveform

## Package Outline Dimensions

## SOT-23-6L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A1	---	0.150	---	0.006
A2	0.900	1.300	0.035	0.051
b	0.300	0.500	0.012	0.019
c	0.100	0.200	0.004	0.008
D	2.800	3.050	0.110	0.120
E1	2.600	3.000	0.103	0.118
F	1.500	1.800	0.059	0.071
e	0.950 TYP		0.037 TYP	
e1	1.900 TYP		0.075 TYP	
L1	0.250	0.600	0.010	0.024
$\theta$	0°	8°	0°	8°